

Global Electronic Adhesive Market - Forecasts from 2018 to 2023

<https://marketpublishers.com/r/G026E3C9634EN.html>

Date: September 2018

Pages: 105

Price: US\$ 3,950.00 (Single User License)

ID: G026E3C9634EN

Abstracts

The global Electronic adhesives market is projected to expand at a CAGR of 13.25% over the forecast period of 2017 - 2023. The use of adhesives in the electronics is widespread and is used not only in the manufacturing of the electronic commodities but also in maintaining the long-term operation of these products. PCB or Printed Circuit Board is the building block of the electronics industry where the use of adhesives is required for bonding surface mount components, wire tacking or fixing and also in the encapsulation of the components. The increasing use of electronic adhesives across various industry verticals including telecommunications, consumer electronics, automotive and many more are driving the market growth. Also, increasing use of consumer electronics, one of the major contributors in promoting the growth of the electronics industry is further fueling the growth of the global electronic adhesives market.

Region-wise, North America is expected to hold the major market share while the Asia Pacific is considered the fastest growing market due to the growing electronics industry in countries like India and China.

The Dow Chemical Company, a Midland Michigan based company has an industry-leading portfolio of specialty chemicals and advanced materials delivering more than 6000 technology-based product families to their customers in around 180 countries across all high-growth sectors which include packaging, electronics, water, coatings, and agriculture. The company's leading portfolio of silicone die attach adhesives delivers proven and dependable bonds in most of the chip demanding applications in automotive, communications, consumer electronics, and industrial markets. DOW CORNING™ die attach adhesives are solventless, environmentally responsible products which cure at a range of temperatures reducing thermal stress and energy consumption.

Major industry players profiled as part of the report are 3M, H.B. Fuller, Master Bond Inc, LG Chem and Henkel Corporation among others.

Segmentation

The global Electronic adhesives market has been analyzed through following segments:

By Type

Electrically conductive adhesives

Thermally conductive adhesives

Ultraviolet-curing adhesives

Others

By Application

Chip bonding

Wire tacking

Potting and encapsulation

Conformal coatings

By Industry Vertical

Telecommunications

Automotive

Consumer Electronics

Defense

Others

By Geography

North America

US

Canada

Mexico

Others

South America

Brazil

Argentina

Others

Europe

UK

Germany

France

Italy

Others

Middle East and Africa

Israel
Saudi Arabia
UAE
Others
Asia Pacific
China
India
Japan
South Korea
Australia
Others

Contents

1. INTRODUCTION

- 1.1. Market Overview
- 1.2. Market Definition
- 1.3. Scope of the Study
- 1.4. Currency
- 1.5. Assumptions
- 1.6. Base, and Forecast Years Timeline

2. RESEARCH METHODOLOGY

- 2.1. Research Design
- 2.2. Secondary Sources

3. EXECUTIVE SUMMARY

4. MARKET DYNAMICS

- 4.1. Market Segmentation
- 4.2. Market Drivers
- 4.3. Market Restraints
- 4.4. Market Opportunities
- 4.5. Porter's Five Force Analysis
 - 4.5.1. Bargaining Power of Suppliers
 - 4.5.2. Bargaining Power of Buyers
 - 4.5.3. Threat of New Entrants
 - 4.5.4. Threat of Substitutes
 - 4.5.5. Competitive Rivalry in the Industry
- 4.6. Life Cycle Analysis - Regional Snapshot
- 4.7. Market Attractiveness

5. GLOBAL ELECTRONIC ADHESIVES MARKET BY TYPE

- 5.1. Electrically conductive adhesives
- 5.2. Thermally conductive adhesives
- 5.3. Ultraviolet-curing adhesives
- 5.4. Others

6. GLOBAL ELECTRONIC ADHESIVES MARKET BY APPLICATION

- 6.1. Chip bonding
- 6.2. Wire tacking
- 6.3. Potting and encapsulation
- 6.4. Conformal coatings

7. GLOBAL ELECTRONIC ADHESIVES MARKET BY INDUSTRY VERTICAL

- 7.1. Telecommunications
- 7.2. Automotive
- 7.3. Consumer electronics
- 7.4. Defense
- 7.5. Others

8. GLOBAL ELECTRONIC ADHESIVES MARKET BY GEOGRAPHY

- 8.1. North America
 - 8.1.1. United States
 - 8.1.2. Canada
 - 8.1.3. Mexico
 - 8.1.4. Others
- 8.2. South America
 - 8.2.1. Brazil
 - 8.2.2. Argentina
 - 8.2.3. Others
- 8.3. Europe
 - 8.3.1. Germany
 - 8.3.2. France
 - 8.3.3. Italy
 - 8.3.4. United Kingdom
 - 8.3.5. Others
- 8.4. Middle East and Africa
 - 8.4.1. Israel
 - 8.4.2. Saudi Arabia
 - 8.4.3. UAE
 - 8.4.4. Others
- 8.5. Asia Pacific

- 8.5.1. Japan
- 8.5.2. China
- 8.5.3. India
- 8.5.4. Australia
- 8.5.5. South Korea
- 8.5.6. Others

9. COMPETITIVE INTELLIGENCE

- 9.1. Market Share Analysis
- 9.2. Recent Deals and Investment
- 9.3. Strategies of Key Players

10. COMPANY PROFILES

- 10.1. DELO Industrie Klebstoffe GmbH & Co. KGaA
 - 10.1.1. Company Overview
 - 10.1.2. Financials
 - 10.1.3. Products and Services
 - 10.1.4. Recent Developments
- 10.2. 3M
 - 10.2.1. Company Overview
 - 10.2.2. Financials
 - 10.2.3. Products and Services
 - 10.2.4. Recent Developments
- 10.3. H.B. Fuller
 - 10.3.1. Company Overview
 - 10.3.2. Financials
 - 10.3.3. Products and Services
 - 10.3.4. Recent Developments
- 10.4. Henkel Corporation
 - 10.4.1. Company Overview
 - 10.4.2. Financials
 - 10.4.3. Products and Services
 - 10.4.4. Recent Developments
- 10.5. Master Bond Inc.
 - 10.5.1. Company Overview
 - 10.5.2. Financials
 - 10.5.3. Products and Services

- 10.5.4. Recent Developments
- 10.6. LG Chem
 - 10.6.1. Company Overview
 - 10.6.2. Financials
 - 10.6.3. Products and Services
 - 10.6.4. Recent Developments
- 10.7. The Dow Chemical Company
 - 10.7.1. Company Overview
 - 10.7.2. Financials
 - 10.7.3. Products and Services
 - 10.7.4. Recent Developments
- 10.8. Avery Dennison Corporation
 - 10.8.1. Company Overview
 - 10.8.2. Financials
 - 10.8.3. Products and Services
 - 10.8.4. Recent Developments
- 10.9. Wacker Chemie AG
 - 10.9.1. Company Overview
 - 10.9.2. Financials
 - 10.9.3. Products and Services
 - 10.9.4. Recent Developments
- 10.10. Kohesi Bond
 - 10.10.1. Company Overview
 - 10.10.2. Financials
 - 10.10.3. Products and Services
 - 10.10.4. Recent Developments

LIST OF FIGURES

LIST OF TABLES

DISCLAIMER

I would like to order

Product name: Global Electronic Adhesive Market - Forecasts from 2018 to 2023

Product link: <https://marketpublishers.com/r/G026E3C9634EN.html>

Price: US\$ 3,950.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G026E3C9634EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970